



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPP034N08N5	<b>Issued</b>	11. August 2021
<b>MA#</b>	MA005447237		
<b>Package</b>	PG-TO220-3-1	<b>Weight*</b>	2038.38 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.149	0.15	0.15	1545	1545
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		401	
	non noble metal	copper	7440-50-8	815.335	40.02	40.07	399990	400511
wire	non noble metal	aluminium	7429-90-5	13.847	0.68	0.68	6793	6793
encapsulation	inorganic material	zinc oxide	1314-13-2	5.902	0.29		2896	
	miscellaneous	miscellaneous	-	23.609	1.16		11582	
	plastics	epoxy resin	-	88.534	4.34		43433	
	inorganic material	silicon dioxide	60676-86-0	472.181	23.16	28.95	231645	289556
lead finish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10529	10529
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121
solder	non noble metal	tin	7440-31-5	0.056			28	
	noble metal	silver	7440-22-4	0.071			35	
	non noble metal	lead	7439-92-1	2.694	0.13	0.13	1322	1385
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		290	
	non noble metal	copper	7440-50-8	589.466	28.92	28.96	289183	289560
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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